

SPECIFICATIONS FOR LCD MODULE

CUSTOMER	STD
MODEL	WM-C1601M-1GNNb
	VER. 2
CUSTOMER	
APPROVED	

APPROVED BY	CHECKED BY	ORGANIZED BY

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History of Version

Version	Chap.	Contents	Date	Note
a1	-	New Version	07.Stp.1995	SPEC.
a2	-	Change as follow by: Wintek 1.Modify Spec. Style	30.NOV.1996	SPEC.
b1	-	Change as follow by: Wintek 1.KS0066UP-00CC→ST7066U-0A	08.AUG.2000	SPEC.
b2	-	Change as follow by: Wintek 1.Modify Spec. Style	16.OCT.2001	SPEC
	- P	- C-la -a -a -		

www.DataSheet



Conte	ents	Page
(1) Electro	onic Units:	4
1.1	Absolute Maximum Ratings	4
1.2	Electrical Characteristics	4
1.3	Interface Pin Function	5
1.4	Power supply for LCD module	6
1.5	Block Diagram with Display RAM Address and Initialization Table	7
1.6	Character Generator ROM Map	8
(2) Electro	o-optical Units:	9
2.1	Electro-optical Characteristics	9
2.2	Optical Definitions	9
(3) Mecha	nical Units:	11
3.1	Mechanical Specification	11
3.2	Mechanical Diagram	12
3.3	Packing Method	13
(4) Quality	/ Units:	14
4.1	Specification of Quality Assurance	14
4.2	Standard Specification for Reliability	21
4.3	Precautions in Use of LCM	23

Reference Data : Sitronix ST7066U-0A Specifications



(1) Electronic Units:

1.1 Absolute Maximum Ratings

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT		
OPERATING TEMPERATURE	T _{OP}	0	-	50	°C		
STORAGE TEMPERATURE	T _{ST}	-20	-	+70	°C		
INPUT VOLTAGE	V _I	-0.3	-	V _{DD} +0.3	V		
SUPPLY VOLTAGE FOR LOGIC	V _{DD} -V _{SS}	-0.3	-	7.0	V		
SUPPLY VOLTAGE FOR LCD	V _{DD} -V ₀	-0.3	-	10.0	V		
STATIC ELECTRICITY	Be sure that you are grounded when handing LCM						

1.2 Electrical Characteristics(Ta= 25°C,V_{DD}=4.5V—5.5V)

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	
SUPPLY VOLTAGE FOR LOGIC	V _{DD} -V _{SS}	-	4.5	5.0	5.5	V	
SUPPLY VOLTAGE FOR LCD	V _{DD} –V ₀		4.3	4.5	4.7	V	
COLLET AGENCE LONGED	(V _{LCD})		7.0	7.	7.7	V	
INPUT HIGH VOL	V_{IH}	-	$0.7V_{DD}$	-	V_{DD}	V	
INPUT LOW VOL	V _{IL}	-	-	-	0.2V _{DD}	V	
OUTPUT HIGH VOL	V _{OH}	I _{OH} =-0.04mA	0.9V _{DD}	-	V _{DD}	V	
OUTPUT LOW VOL.	V _{OL}	I _{OL} =0.04mA	-	-	0.1V _{DD}	V	
SUPPLY CURRENT FOR LOGIC	*I _{DD}	V _{DD} = 5V	-	2.5	3.0	mA	
USED IC	ST7066U-0A						

^{*}I_{DD} Measurement condition is for all pixels on display



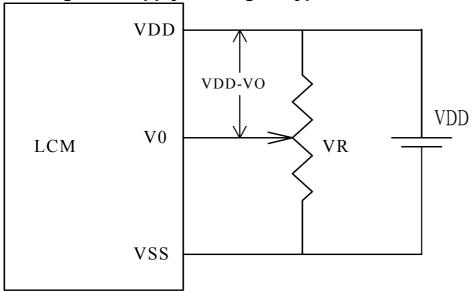
1.3 Interface Pin Function

NO	SYMBOL	1/0	FUNCTION
1	Vss	Р	GND (0V)
2	V _{DD}	Р	VDD (+5V ±5%)
3	Vo	Р	CONTRAST ADJUSTMENT
4	RS	I	REGISTER SELECT SIGNAL
5	R/W	I	READ / WRITE SELECTION
6	E	I	ENABLE SIGNAL
7	DB0	I/O	
8	DB1	I/O	
9	DB2	I/O	
10	DB3	I/O	DATA BUS
11	DB4	I/O	
12	DB5	I/O	
13	DB6	I/O	
14	DB7	I/O	
15	NC	-	NO CONNECTION
16	NC	-	NO CONNECTION



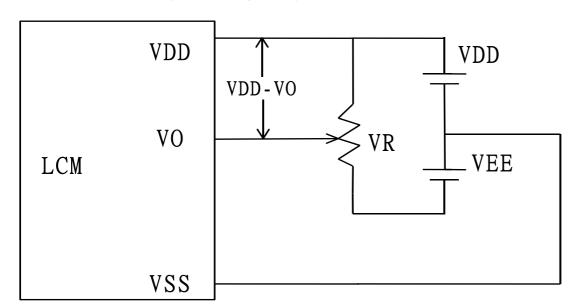
1.4 Power Supply for LCD Module

14.1 Signal Supply Voltage Types



 V_{DD} - V_{O} : LCD Driving Voltage

14.2 Dual Supply Voltage Types

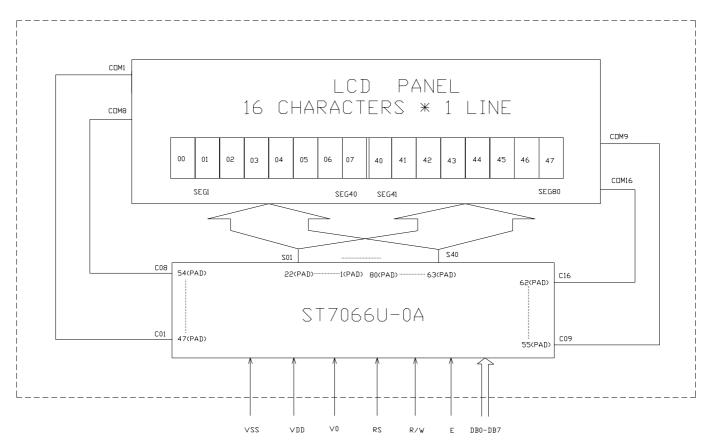


 V_{DD} - V_{O} : LCD Driving Voltage



1.5 Block Diagram with Display RAM Address and Initialization Table

Relations between DDRAM addresses and positions on the LCD are shown below. The DDRAM address (ADD) is set in the address counter (AC) and is represented in hexadecimal.



Initialization Table:

	Instruction	Code	Description
1	Function Set	001110××	8-BIT, 2-LINE,5×8 DOTS,1/16 Duty



1.6 Character Generator ROM Map

b7-b4	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
P3-P0																
0000	CG RAM (1)															
0001	(2)															
0010	(3)															
0011	(4)															
0100	(5)															
0101	(6)															
0110	3															
0111	(8)															
1000	(1)															
1001	(2)															
1010	(3)															
1011	(4)															
1100	(5)															
1101	(6)															
1110	(7)															
11111	v (8) ^{a1}			. .												

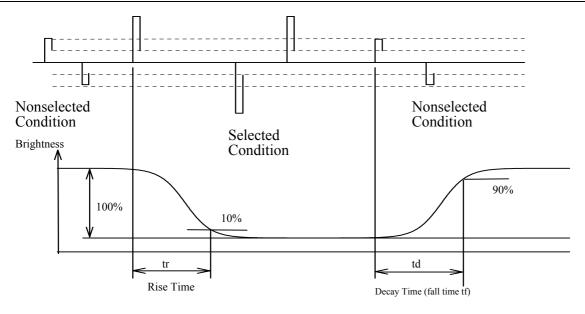


(2) Electro-optical Units

2.1 Electro-optical Characteristics

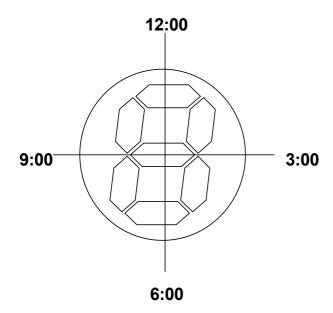
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT		
VIEW ANGLE (V)	θ	CR≧2	-40	-	+40	deg.		
VIEW ANGLE (H)	Ø	CR≧2	-40	-	+40	deg.		
CONTRAST RATIO	CR	Ta=25°C	-	4	-	-		
RESPONSE TIME	tr	Ta=25°ℂ	ı	200	400	ms		
RESPONSE TIME	td	Ta=25°C	-	200	400	ms		
OPERATING VOLTAGE FOR LCD	V _{LCD}	Ta=25°C	-	4.5	-	V		
DRIVE METHOD	DUTY	TY 1/16						
DRIVE METHOD	BIAS	BIAS 1/5						
LCD TYPE	STN - Gray (Positive / Reflective)							
VIEWING DIRECTION		6	O'CLOCK					

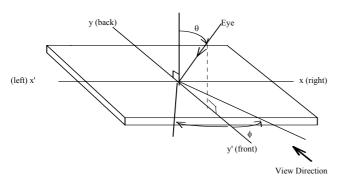
2.2 Optical Definitions



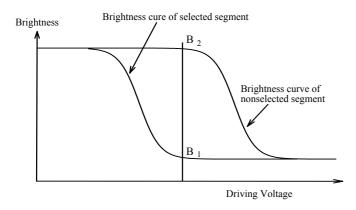
Response Time







View Angle



Perpendicular line (θ=90°)

Brightness at nonselected segment (B2)

Contrast ration = Brightness at selected segment (B1)

Contrast ration (CR)



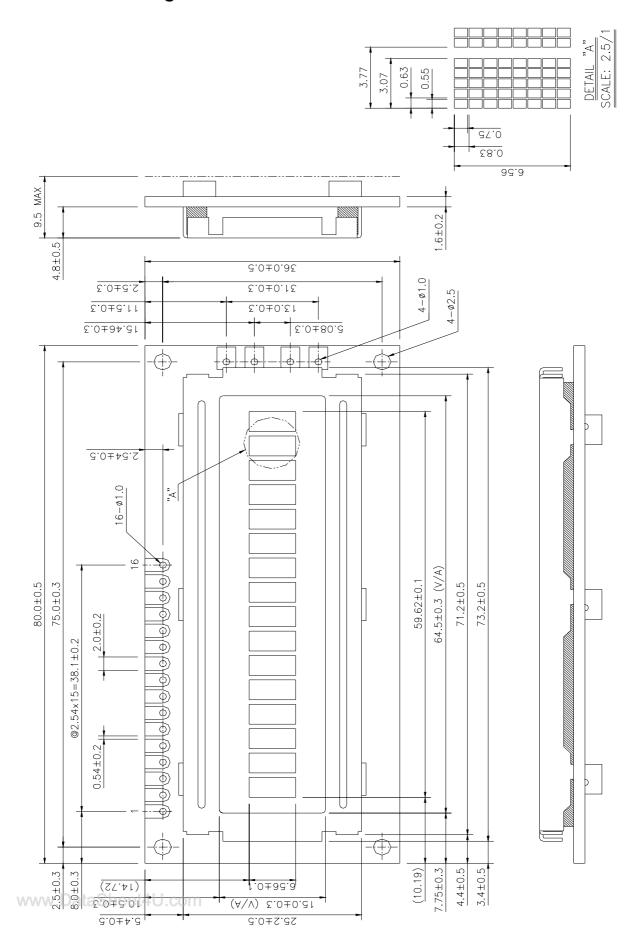
(3) Mechanical Units

3.1 Mechanical Specification

ITEM	STANDARD VALUE	UNIT
NUMBER OF CHARACTERS	16 CHARACTERS × 1 LINE	-
CHARACTER FORMAT	5 x 8 DOTS	-
MODULE DIMENSION	80.0 (W) \times 36.0 (H) \times 9.5 MAX(T)	mm
VIEWING AREA	64.5 (W) × 15.0 (H)	mm
ACTIVE AREA	59.62 (W) × 6.56 (H)	mm
CHARACTER SIZE	3.07 (W) × 6.56 (H)	mm
CHARACTER PITCH	3.77 (W) × 6.56 (H)	mm
DOT SIZE	0.55 (W) × 0.75 (H)	mm
DOT PITCH	0.63 (W) × 0.83 (H)	mm
APPROX. WEIGHT	26	g



3.2 Mechanical Diagram





3.3 Packing Method

1. Packaging Material: (per carton)

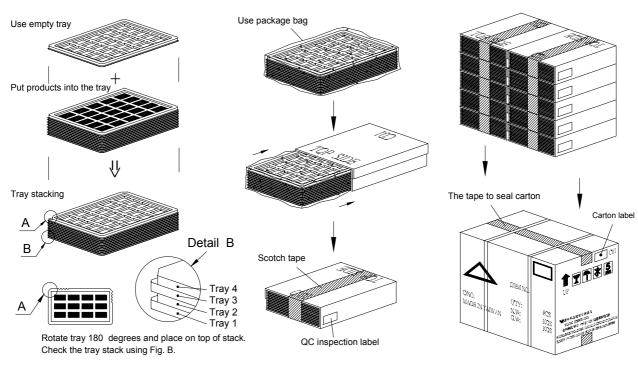
NO	Item	Model		Dimensions (mm)	Unit Weight (Kg)	Quantity
1	LCM Module	WM-C1601M-1GNNb		122.0*33.0	0.026	320
2	Tray	V186 PETA		320*217	0.06	50
3	Product Box	C01		320*219*70	0.131	10
4	Carton	C61		475*345*389	1.208	1
5	Package Bag	C5		467*321*0.08	0.023	10
6	Total Weight	1.	4.1	Kg ± 5%		

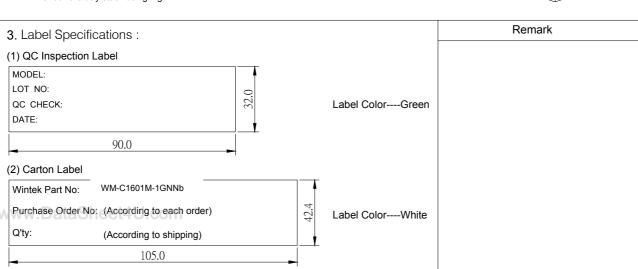
2. Packaging Specifications and Quantity:

(1) LCM quantity per tray : no per row $2 \times x$ no per column 4 = 8

(2) LCM quantity per box : no of trays 8 x quantity per tray 4 = 32

(3) Total LCM quantity in carton : no of boxes 32 x quantity per box 10 = 320







(4) Quality Units

4.1 Specification of Quality Assurance

1.Purpose

This standard for Quality Assurance should affirm the quality of LCD module products to supply to purchaser by WINTEK CORPORATION (Supplier).

2. Standard for Quality Test

2.1 Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

2.2 Electro-Optical Characteristics:

According to the individual specification to test the product.

2.3 Test of Appearance Characteristics:

According to the individual specification to test the product.

2.4 Test of Reliability Characteristics:

According to the definition of reliability on the specification for testing products.

2.5 Delivery Test:

Before delivering, the supplier should take the delivery test.

- 2.5.1 Test method: According to MIL-STD-105E, General Inspection Level $\, {\rm II} \,$ take a single time.
- 2.5.2 The defects classify of AQL as following:

Major defect: AQL=0.65
Minor defect: AQL=2.5
Total defects: AQL=2.5

3. Nonconforming Analysis & Deal With Manners

- 3.1 Nonconforming analysis:
 - 3.1.1 Purchaser should supply the detail data of non-conforming sample and the non-suitable state.
 - 3.1.2 After accepting the detail data from purchaser, the analysis of nonconforming should be finished in two weeks.
 - 3.1.3 If supplier can not finish analysis on time, must announce purchaser before two weeks.
- 3.2 Disposition of nonconforming:
 - 3.2.1 If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.
- WWW 3.2.2 Both supplier and customer should analyze the reason and discuss the disposition of nonconforming when the reason of nonconforming is not sure.



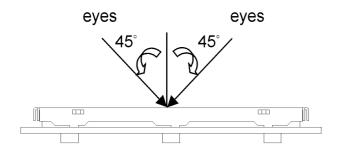
4. Agreement items

Both sides should discuss together when the following problems happen.

- 4.1 There is any problem of standard of quality assurance, and both sides think that it must be modified.
- 4.2 There is any argument item which does not record in the standard of quality assurance.
- 4.3 Any other special problem.

5. Standard of The Product Appearance Test

- 5.1 Manner of appearance test:
 - 5.1.1 The test must be under 20W \times 2 or 40W fluorescent light, and the distance of view must be at 30 cm.
 - 5.1.2 When test the model of transmissive product must add the reflective plate.
 - 5.1.3 The test direction is base on about around 45° of vertical line.

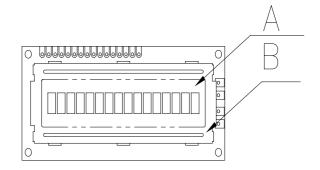


5.1.4 Definition of area:

A Area: Viewing area.

B Area: Out of viewing area.

(Outside viewing area)



5.2 Basic principle:

- 5.2.1 It will accord to the AQL when the standard can not be described.
- 5.2.2 The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
- 5.2.3 Must add new item on time when it is necessary.
- 5.3 Standard of inspection: (Unit: mm)



6. Inspection specification

NO	Item	Criterion			AQL		
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 					
02	Black or white spots on LCD (display only)	I throp white or block coets brecopt			2.5		
	LCD black spots,white spots, contamination (non-display)	3.1 Round type:	As follow	ving drawing			
		$\phi = (\mathbf{x} + \mathbf{y})/$	2	SIZE	Acceptable Q TY		
03					<i>φ</i> ≦0.10	Accept no dense	
			$\xrightarrow{X} \leftarrow \frac{\downarrow}{\uparrow}$	0.1	0 \leq ϕ \leq 0.20	2	2.5
		• •	Y 0.2	$0 < \phi \le 0.25$	1		
		l	0.2	25 < ψ	0		
		I SZIINA WAA CAS INIINWIN	g drawing)				
			Length	Width	Acceptable Q TY		
			→		W≦0.0	O2 Accept no dense	
			L≤3.0	0.02 <w≤0.0< td=""><td>03</td><td>2.5</td></w≤0.0<>	03	2.5	
		→	L≦2.5	0.03≤W≦0.0	05 2		
				0.05 < W	As round type		



NO	Item	Criterion			AQL
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications ,not easy to find, must check in specify direction	Size ϕ $\phi \leq 0.20$ $0.20 < \phi \leq 0.50$ $0.50 < \phi \leq 1.00$ $1.00 < \phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination			
06	Chipped glass	L: Electrode pad length 6.1 General glass chip 6.1.1Chip on panel surfa	Glass thickness : ace and crack between y k y: Chip width Not over viewing are Not exceed 1/3k e chips, x is the tota y: Chip width Not over viewing are Not exceed 1/3k	a: LCD side length en panels: $x : Chip length$ a $x \le 1/8a$ $x \le 1/8a$ I length of each chip. $x : Chip length$ ea $x \le 1/8a$ $x \le 1/8a$ $x \le 1/8a$	2.5



NO	Item	Criterion			
		x : Chip length y : Chip width z : Chip thickness k : Seal width t : Glass thickness a : LCD side length L : Electrode pad length 6.2 Protrusion over terminal :			
	$y : Chip \ width \qquad x : Chip \ length \qquad z : Chip \ thickness$ $y \le 0.5 \ mm \qquad x \le 1/8a \qquad 0 < z \le t$				
		6.2.2 Non-conductive portion:			
06	Glass crack	y z z z z	2.5		
		y: Chip width x: Chip length z: Chip thickness			
		$y \le L \qquad x \le 1/8a \qquad 0 < z \le t$			
		 ○If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. ○If the product will be heat sealed by the customer, the alignment mark must not be damaged. 			
		6.2.3 Substrate protuberance and internal crack.			
		y: width x: length			
		$y = 1/3L$ $x \le a$			



NO	Item	Criterion	
07	Cracked glass	The LCD with extensive crack is not acceptable.	
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratches that appear when lit must be judged . using LCD spot, lines and contamination standards. 8.3 Backlight doesn t light or color is wrong. 	
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	
10	PCB COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hole pad, make sure it is smoothed down. 	2.5 2.5 0.65 2.5 0.65 0.65
11	Soldering	 11.1 No unmelted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65





4.2 Standard Specification for Reliability

1.Standard Specifications for Reliability of LCD Module

No	Item	Description		
01	High temperature operation	The sample should be allowed to stand at $_{50}$ $^{\circ}\mathrm{C}$ for 240 (-0, +48) hours under driving condition.		
02	Low temperature operation	The sample should be allowed to stand at $_0$ $^{\circ}\mathrm{C}$ for 240 (-0, +48) hours under driving condition.		
03	High temperature resistance	The sample should be allowed to stand at 70 °C for 240 (-0,+48) hours under no-load condition, and then returning it to normal temperature condition, and allowing it stand for 30 minutes.		
04	Low temperature resistance	The sample should be allowed to stand at -20°C for 240 (-0,+48) hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 24 hours.		
05	Moisture resistance	The sample should be allowed to stand at 40° C , 90 % RH MAX for 240 (-0,+48) hours under no-load condition excluding the polarizer, then taking it out and drying it at normal temperature.		
06	Thermal shock resistance	The sample should be allowed to stand the following 10 cycles of operation: $-40~^{\circ}\!$		
07	ESD (Electrostatic Discharge)	Human Body Model: 2000 volt electrical discharge from a 100 pF capacitor to the tested device in series with a 1500 ohm resistor. Apply V _{DD} & V _{SS} to LCD module unit. Test for functionality no missing lines after the discharge, but LCD module may reset. Machine Model: 200 volt electrical discharge from a 200 pF capacitor to the tested device with no series resistance. Apply to V _{DD} & V _{SS} to LCD module unit without including hand phone. Test for functionality no any missing line after the discharge but LCD module can be reset if display off.		



2. Testing Conditions and Inspection Criteria

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in Table 4.2, Standard specifications for Reliability have been executed in order to ensure stability.

NO	Item	Test Model	Inspection Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

3.Life Time

Life time	Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (25 \pm 10°C), normal humidity (45 \pm 20% RH), and in area not exposed to direct sun light. (Life time of backlight, please refer to Data about backlight .)
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Note: From our experience the life time of high humidity operation and high temperature operation as above mentioned could be achieved.



4.3 Precautions in Use of LCM

4.3.1 Handling of LCM

- Don't give external shock.
- Don't apply excessive force on the surface.
- Liquid in LCD is hazardous substance. Must not lick and swallow. when the liquid is attach to your hand, skin, cloth etc. Wash it out thoroughly and immediately.
- Don't operate it above the absolute maximum rating.
- Don't disassemble the LCM.

4.3.2 Storage

- Store in an ambient temperature of 5°C to 45°C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.
- Storage in a clean environment, free from dust, active gas, and solvent.
- Store in anti-static electricity container.
- Store without any physical load.

4.3.3 Soldering

- Use the high quality solder. (60-63% tin mixed with lead)
- Iron: no higher than 260°C and less than 3-4 sec during soldering.
- Soldering: only to the I/O terminals.
- Rewiring: no more than 3 times.